

# TPS3435-Q1 Automotive Nano IQ Precision Timeout Watchdog Timer

#### 1 Features

- AEC-Q100 qualified with the following results:
  - Device temperature grade 1: –40°C to 125°C ambient operating temperature range
- Factory programmed or user-programmable watchdog timeout
  - ±10% Accurate timer (maximum)
  - Factory programmed: 1ms to 100s
- Factory programmed or user-programmable reset delay
  - ±10% Accurate timer (maximum)
  - Factory programmed option: 2ms to 10s
- Input voltage range:  $V_{DD} = 1.04V$  to 6.0V
- Ultra low supply current: I<sub>DD</sub> = 250nA (typical)
- Open-drain, push-pull; active-low outputs
- Various programmability options:
  - Watchdog enable-disable
  - Watchdog startup delay: no delay to 10s
  - On the fly timer extension: 1X to 256X
  - Latched output option
- MR functionality support

# 2 Applications

- On-board (OBC) and wireless charger
- **Driver monitoring**
- Battery Management System (BMS)
- Front camera
- Surround view system ECU

### 3 Description

The TPS3435-Q1 is an ultra-low power consumption (250nA typical) device offering a programmable timeout watchdog timer.

The TPS3435-Q1 offers a high accuracy timeout watchdog timer with a host of features for a wide variety of applications. The timeout watchdog timer can be factory programmed or user programmed using an external capacitor. The timer value can be changed on-the-fly using a combination of logic pins. The watchdog also offers unique features such as enable-disable, start-up delay.

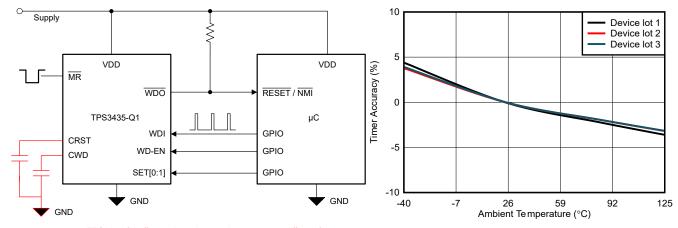
The WDO delay can be set by factory-programmed default delay settings or programmed by an external capacitor. The device also offers a latched output operation where the output is latched until the watchdog fault is cleared.

The TPS3435-Q1 provides a performance upgrade alternative to TPS3431-Q1 device family. The TPS3435-Q1 is available in a small 8-pin SOT-23 package.

#### **Device Information**

| PART NUMBER | PACKAGE (1) | BODY SIZE (NOM) |
|-------------|-------------|-----------------|
| TPS3435-Q1  | DDF (8)     | 2.90mm × 1.60mm |

- For all available packages, see the orderable addendum at the end of the data sheet.
- The package size (length × width) is a nominal value and includes pins, where applicable.



TPS3435-Q1 offers various pinout options to support different features. Choose the suitable pinout based on application needs

Typical Application Circuit



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# **4 Device Comparison**

Figure 4-1 shows the device naming nomenclature of the TPS3435-Q1. For all possible output types, watchdog time options and output assert delay options, see Section 7 or Table 4-1 for more details. Contact TI sales representatives or on TI's E2E forum for detail and availability of other options.

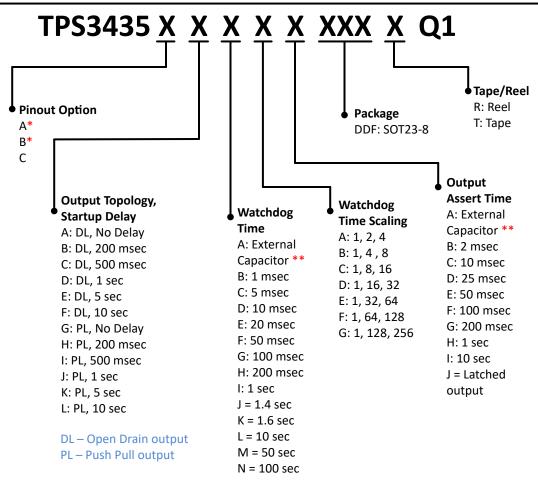
Table 4-1. Available devices

| Device             | Function (1) | Pinout (2) | WD Timeout | Startup-<br>Delay | Time<br>Scaling | Output<br>Pulse | Output<br>Topology | Vit-  |
|--------------------|--------------|------------|------------|-------------------|-----------------|-----------------|--------------------|-------|
| TPS3435CAEBJDDFR   | WD           | С          | 20ms       | 0                 | 1, 4, 8         | Latched         | open-drain         | N/A   |
| TPS3435CAGBJDDFRQ1 | WD           | С          | 100ms      | 0                 | 1, 4, 8         | Latched         | open-drain         | N/A   |
| TPS3435CBHAJDDFR   | WD           | С          | 200ms      | 200ms             | 1, 2, 4         | Latched         | open-drain         | N/A   |
| TPS3435CCGAJDDFR   | WD           | С          | 100ms      | 500ms             | 1, 2, 4         | Latched         | open-drain         | N/A   |
| TPS3435CECAJDDFRQ1 | WD           | С          | 5ms        | 5s                | 1, 2, 4         | Latched         | open-drain         | N/A   |
| TPS3435CGLEFDDFR   | WD           | С          | 10s        | 0                 | 1, 32, 64       | 100ms           | push-pull          | N/A   |
| TPS3435CAKAGDDFR   | WD           | С          | 1.6s       | 0                 | 1, 2, 4         | 200ms           | open-drain         | N/A   |
| TPS3435AFACADDFRQ1 | WD           | Α          | Adjustable | 10s               | 1, 8            | Adjustable      | open-drain         | N/A   |
| TPS3435CAKAGDDFRQ1 | WD           | С          | 1.6s       | 0                 | 1, 2, 4         | 200ms           | open-drain         | N/A   |
| TPS3435CAIEGDDFR   | WD           | С          | 1s         | 0                 | 1, 32, 64       | 200ms           | open-drain         | N/A   |
| TPS3435JAJAJDSER   | WD           | J          | 1.4s       | 0                 | 1, 2            | Latched         | open-drain         | N/A   |
| TPS3435JFMAFDSER   | WD           | J          | 50s        | 10s               | 1, 2            | 100ms           | open-drain         | N/A   |
| TPS35CA38GACDDFRQ1 | WD + SVS     | С          | 100ms      | 0                 | 1, 2, 4         | 10ms            | open-drain         | 2.9V  |
| TPS35DA40GCJDDFR   | WD + SVS     | D          | 100ms      | 0                 | 1, 8, 16        | Latched         | open-drain         | 3V    |
| TPS35DA69GADDDFRQ1 | WD + SVS     | D          | 100ms      | 0                 | 1, 2, 4         | 25ms            | open-drain         | 4.45V |
| TPS35JE42IADDSER   | WD + SVS     | J          | 1s         | 20ms              | 1, 2            | 25ms            | open-drain         | 3.1V  |
| TPS35AA17AGADDFR   | WD + SVS     | Α          | Adjustable | 0                 | 1, 128          | Adjustable      | open-drain         | 1.85V |
| TPS35JE35JADDSER   | WD + SVS     | J          | 1.4s       | 5s                | 1, 2            | 25ms            | open-drain         | 2.75V |
| TPS35AA38AGADDFRQ1 | WD + SVS     | Α          | Adjustable | 0                 | 1, 128          | Adjustable      | open-drain         | 2.9V  |
| TPS35CA43DACDDFRQ1 | WD + SVS     | С          | 10ms       | 0                 | 1, 2, 4         | 10ms            | open-drain         | 3.15V |
| TPS35CA38IAGDDFRQ1 | WD + SVS     | С          | 1s         | 0                 | 1, 2, 4         | 200ms           | open-drain         | 2.9V  |

<sup>(1)</sup> WD = Watchdog , SVS = Voltage Supervisor

<sup>(2)</sup> Please refer to Section 5 for pinout information





<sup>\*</sup> Pinout option supports Start up Delay settings of "No Delay" and "10 sec" only.

Refer 'Mechanical, Packaging and Orderable Information' section for list of released orderable. For any other orderable, contact local TI support.

Figure 4-1. Device Naming Nomenclature

TPS3435-Q1 belongs to family of pin compatible devices offering different feature sets as highlighted in Table 4-2.

**Table 4-2. Pin Compatible Device Families** 

| DEVICE     | VOLTAGE SUPERVISOR | TYPE OF WATCHDOG |
|------------|--------------------|------------------|
| TPS35-Q1   | Yes                | Timeout          |
| TPS36-Q1   | Yes                | Window           |
| TPS3435-Q1 | No                 | Timeout          |
| TPS3436-Q1 | No                 | Window           |

<sup>\*\*</sup> Capacitor programmable time feature available with pinout options A & B. For fixed time and latched output features use pinout option C.



# **5 Pin Configuration and Functions**

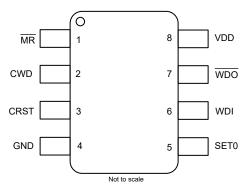


Figure 5-1. Pin Configuration Option A DDF Package, 8-Pin SOT-23, TPS3435-Q1 Top View

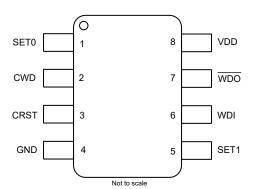


Figure 5-2. Pin Configuration Option B DDF Package, 8-Pin SOT-23, TPS3435-Q1 Top View

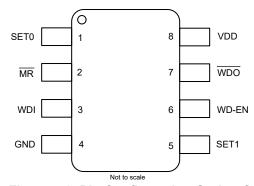


Figure 5-3. Pin Configuration Option C DDF Package, 8-Pin SOT-23, TPS3435-Q1 Top View

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## **Table 5-1. Pin Functions**

|             | Р           | PIN NUMBER  |             |     | ole 3-1. I ill I unctions  |  |
|-------------|-------------|-------------|-------------|-----|--|--|
| PIN<br>NAME | PINOUT<br>A | PINOUT<br>B | PINOUT<br>C | I/O | DESCRIPTION  |  |
| CRST        | 3           | 3           | _           | I   | Programmable WDO assert time pin. Connect a capacitor between this pin and GND to program the WDO assert time period. See <i>Section 7.3.3</i> for more details.                                     |  |
| CWD         | 2           | 2           | _           | I   | Programmable watchdog timeout input. Watchdog timeout is set by connecting capacitor between this pin and ground. See Section 7.3.1.1 for more details.  |  |
| GND         | 4           | 4           | 4           | _   | Ground pin   |  |
| MR          | 1           | _           | 2           | I   | Manual reset pin. A logic low on this pin asserts the WDO output. See Section 7.3.2 for more details.  |  |
| WDO         | 7           | 7           | 7           | 0   | Watchdog output. Connect WDO to VDD using pull up resistance when using open drain output. WDO is asserted when a watchdog error occurs or MR pin is driven LOW. See Section 7.3.3 for more details. |  |
| SET0        | 5           | 1           | 1           | I   | Logic input. SET0, SET1, and WD-EN pins select the watchdog timer scaling and enable-disable the watchdog; see Section 7.3.1.4 for more details.   |  |
| SET1        | _           | 5           | 5           | I   | Logic input. SET0, SET1, and WD-EN pins select the watchdog timer scaling and enable-disable the watchdog; see Section 7.3.1.4 for more details.   |  |
| VDD         | 8           | 8           | 8           | I   | Supply voltage pin. For noisy systems, connecting a 0.1µF bypass capacitor is recommended.   |  |
| WD-EN       | _           | _           | 6           | I   | Logic input. Logic high input enables the watchdog monitoring feature. See Section 7.3.1.2 for more details.   |  |
| WDI         | 6           | 6           | 3           | ı   | Watchdog input. A falling transition (edge) must occur at this pin before the timeout expires in order for WDO to not assert. See Section 7.3.1 for more details.                                    |  |

## **6 Specifications**

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range, unless otherwise noted<sup>(1)</sup>

|                 |  | MIN                                  | MAX | UNIT |
|-----------------|--|--------------------------------------|-----|------|
| Voltage         | VDD  | -0.3                                 | 6.5 | V    |
| Voltage         | C <sub>WD</sub> , C <sub>RST</sub> , WD–EN, SETx, WDI, MR (2), WDO (Push Pull) | WDO (Push Pull) -0.3 V <sub>DD</sub> |     | V    |
| Voltage         | WDO (Open Drain)   | -0.3                                 | 6.5 | V    |
| Current         | WDO pin  | -20                                  | 20  | mA   |
| Temperature (4) | Operating ambient temperature, T <sub>A</sub>                                  | -40                                  | 125 | °C   |
| Temperature     | Storage, T <sub>stg</sub>  | -65                                  | 150 | C    |

- (1) Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) If the logic signal driving  $\overline{MR}$  is less than  $V_{DD}$ , then additional current flows into  $V_{DD}$  and out of  $\overline{MR}$ .
- (3) The absolute maximum rating is (VDD + 0.3)V or 6.5V, whichever is smaller
- (4) As a result of the low dissipated power in this device, it is assumed that T<sub>J</sub> = T<sub>A</sub>.

### 6.2 ESD Ratings

|   |       |                         |   | VALUE | UNIT |
|---|-------|-------------------------|---|-------|------|
| V |       | Electrostatic discharge | Human body model (HBM), per AEC Q100-002 <sup>(1)</sup> | ±2000 | V    |
| ( | (ESD) | Lieurostatio discriarge | Charged device model (CDM), per AEC Q100-011            | ±750  | '    |

<sup>(1)</sup> AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

#### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                  |   | MIN | NOM MAX | UNIT |
|------------------|---|-----|---------|------|
|                  | VDD (Active Low output)                                       | 0.9 | 6       |      |
| Voltage          | C <sub>WD</sub> , C <sub>RST</sub> , WD–EN, SETx, WDI, MR (1) | 0   | VDD     | V    |
| Voltage          | WDO (Open Drain)  | 0   | 6       | V    |
|                  | WDO (Push Pull)   | 0   | VDD     |      |
| Current          | WDO pin current   | -5  | 5       | mA   |
| C <sub>RST</sub> | C <sub>RST</sub> pin capacitor range                          | 1.5 | 1800    | nF   |
| C <sub>WD</sub>  | C <sub>WD</sub> pin capacitor range                           | 1.5 | 1000    | nF   |
| T <sub>A</sub>   | Operating ambient temperature                                 | -40 | 125     | °C   |

<sup>(1)</sup> If the logic signal driving  $\overline{MR}$  is less than  $V_{DD}$ , then additional current flows into  $V_{DD}$  and out of  $\overline{MR}$ .  $V_{MR}$  should not be higher than  $V_{DD}$ .



### **6.4 Thermal Information**

|                       |  | TPS3435-Q1 |      |
|-----------------------|--|------------|------|
|                       | ### THERMAL METRIC(1)  ### DDF (SOT23-8)  ### B PINS  ### B PINS | UNIT       |      |
|                       |  | 8 PINS     |      |
| $R_{\theta JA}$       | Junction-to-ambient thermal resistance   | 175.3      | °C/W |
| R <sub>θJC(top)</sub> | Junction-to-case (top) thermal resistance  | 94.7       | °C/W |
| R <sub>0JB</sub>      | Junction-to-board thermal resistance   | 92.4       | °C/W |
| $\Psi_{JT}$           | Junction-to-top characterization parameter   | 8.4        | °C/W |
| ΨЈВ                   | Junction-to-board characterization parameter   | 91.9       | °C/W |
| R <sub>θJC(bot)</sub> | Junction-to-case (bottom) thermal resistance   | N/A        | °C/W |

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



### 6.5 Electrical Characteristics

At  $1.04\text{V} \le \text{V}_{DD} \le 6\text{V}$ ,  $\overline{\text{MR}}$  = Open,  $\overline{\text{WDO}}$  pull-up resistor ( $R_{\text{pull-up}}$ ) =  $100\text{k}\Omega$  to VDD, output load ( $C_{\text{LOAD}}$ ) = 10pF and over operating free-air temperature range  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ , unless otherwise noted. VDD ramp rate  $\le 1\text{V}/\mu\text{s}$ . Typical values are at  $T_A = 25^{\circ}\text{C}$ 

|                      | PARAMETER   | TEST CONDITIONS  | MIN                | TYP  | MAX                | UNIT |
|----------------------|---|--|--------------------|------|--------------------|------|
| СОММС                | ON PARAMETERS                                     |  |                    |      |                    |      |
| $V_{DD}$             | Input supply voltage                              | Active LOW output  | 1.04               |      | 6                  | V    |
|                      | Supply ourrent into VDD pin (1)                   | T <sub>A</sub> = -40°C to 85°C                                     |                    | 0.25 | 0.8                |      |
| I <sub>DD</sub>      | Supply current into VDD pin (1)                   |  |                    | 0.25 | 3                  | μA   |
| V <sub>IL</sub>      | Low level input voltage WD–EN, WDI, SETx, MR (1)  |  |                    |      | 0.3V <sub>DD</sub> | V    |
| V <sub>IH</sub>      | High level input voltage WD–EN, WDI, SETx, MR (1) |  | 0.7V <sub>DD</sub> |      |                    | V    |
| R <sub>MR</sub>      | Manual reset internal pull-up resistance          |  |                    | 100  |                    | kΩ   |
| WDO (O               | pen-drain active-low)                             |  |                    |      | 1                  |      |
| V                    | Low level output voltage                          | V <sub>DD</sub> =1.5V<br>I <sub>OUT(Sink)</sub> = 500μA            |                    |      | 300                | mV   |
| V <sub>OL</sub>      |   | $V_{DD} = 3.3V$<br>$I_{OUT(Sink)} = 2mA$                           |                    |      | 300                | IIIV |
| I <sub>lkg(OD)</sub> | Open-Drain output leakage current                 | $V_{DD} = V_{PULLUP} = 6V$<br>$T_A = -40$ °C to 85°C               |                    | 10   | 30                 | nA   |
|                      |   | V <sub>DD</sub> = V <sub>PULLUP</sub> = 6V                         |                    | 10   | 60                 | nA   |
| WDO (P               | ush-pull active-low)                              |  |                    |      |                    |      |
| V <sub>POR</sub>     | Power on WDO voltage (2)                          | V <sub>OH(min)</sub> = 0.8 VDD<br>I <sub>out (source)</sub> = 15μA |                    |      | 900                | mV   |
| V <sub>OL</sub>      | Low level output voltage                          | $V_{DD} = 1.5V$<br>$I_{OUT(Sink)} = 500\mu A$                      |                    |      | 300                | mV   |
| V OL                 |   | $V_{DD} = 3.3V$<br>$I_{OUT(Sink)} = 2mA$                           |                    |      | 300                | IIIV |
|                      |   | V <sub>DD</sub> = 1.8V<br>I <sub>OUT(Source)</sub> = 500μA         | 0.8V <sub>DD</sub> |      |                    |      |
| V <sub>OH</sub>      | High level output voltage                         | V <sub>DD</sub> = 3.3V<br>I <sub>OUT(Source)</sub> = 500μA         | 0.8V <sub>DD</sub> |      |                    | ٧    |
|                      |   | V <sub>DD</sub> = 6V<br>I <sub>OUT(Source)</sub> = 2mA             | 0.8V <sub>DD</sub> |      |                    |      |

<sup>(1)</sup> If the logic signal driving  $\overline{MR}$  is less than  $V_{DD}$ , then additional current flows into  $V_{DD}$  and out of  $\overline{MR}$ .

<sup>(2)</sup> V<sub>POR</sub> is the minimum V<sub>DD</sub> voltage level for a controlled output state



## 6.6 Timing Requirements

At 1.04V  $\leq$  V<sub>DD</sub>  $\leq$  6V,  $\overline{MR}$  = Open,  $\overline{WDO}$  pull-up resistor (R<sub>pull-up</sub>) = 100k $\Omega$  to VDD, output RESET / WDO load (C<sub>LOAD</sub>) = 10pF and over operating free-air temperature range –40°C to 125°C, unless otherwise noted. VDD ramp rate  $\leq$  1V/ $\mu$ s. Typical values are at T<sub>A</sub> = 25°C

|                      | PARAMETER  | TEST CONDITIONS             | MIN  | TYP | MAX  | UNIT |
|----------------------|--|-----------------------------|------|-----|------|------|
| t MR_PW              | MR pin pulse duration to assert output                           |                             |      | 100 |      | ns   |
| t <sub>P-WD</sub>    | WDI pulse duration to start next frame (1)                       |                             | 500  |     |      | ns   |
| t <sub>HD-WDEN</sub> | WD–EN hold time to enable or disable WD operation <sup>(1)</sup> |                             | 200  |     |      | μs   |
| t <sub>HD-SETx</sub> | SETx hold time to change WD timer setting                        |                             | 150  |     |      | μs   |
|                      |  | Orderable Option TPS3435xxB | 0.8  | 1   | 1.2  |      |
|                      |  | Orderable Option TPS3435xxC | 4    | 5   | 6    |      |
|                      |  | Orderable Option TPS3435xxD | 9    | 10  | 11   |      |
|                      |  | Orderable Option TPS3435xxE | 18   | 20  | 22   | ms   |
|                      |  | Orderable Option TPS3435xxF | 45   | 50  | 55   | -    |
|                      |  | Orderable Option TPS3435xxG | 90   | 100 | 110  |      |
| $t_{WD}$             | Watchdog timeout period  | Orderable Option TPS3435xxH | 180  | 200 | 220  |      |
|                      |  | Orderable Option TPS3435xxI | 0.9  | 1   | 1.1  |      |
|                      |  | Orderable Option TPS3435xxJ | 1.26 | 1.4 | 1.54 | s    |
|                      |  | Orderable Option TPS3435xxK | 1.44 | 1.6 | 1.76 |      |
|                      |  | Orderable Option TPS3435xxL | 9    | 10  | 11   |      |
|                      |  | Orderable Option TPS3435xxM | 45   | 50  | 55   |      |
|                      |  | Orderable Option TPS3435xxN | 90   | 100 | 110  |      |

(1) Not production tested

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## **6.7 Switching Characteristics**

At  $1.04\text{V} \le \text{V}_{DD} \le 6\text{V}$ ,  $\overline{\text{MR}}$  = Open,  $\overline{\text{WDO}}$  pull-up resistor ( $R_{\text{pull-up}}$ ) =  $100\text{k}\Omega$  to VDD, output RESET / WDO load ( $C_{\text{LOAD}}$ ) = 10pF and over operating free-air temperature range  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ , unless otherwise noted. VDD ramp rate  $\le 1\text{V}/\mu\text{s}$ . Typical values are at  $T_A$  =  $25^{\circ}\text{C}$ 

|                   | PARAMETER                                      | TEST CONDITIONS   | MIN  | TYP | MAX  | UNIT |
|-------------------|--|---|------|-----|------|------|
| t <sub>STRT</sub> | Startup delay <sup>(1)</sup>                   |   |      |     | 500  | μs   |
|                   |  | Orderable part number<br>TPS3435xA, TPS3435xG                           |      | 0   |      |      |
|                   |  | Orderable part number<br>TPS3435xB, TPS3435xH                           | 180  | 200 | 220  | ms   |
|                   | Watchdog startus dalou                         | Orderable part number<br>TPS3435xC, TPS3435xI                           | 450  | 500 | 550  |      |
| t <sub>SD</sub>   | Watchdog startup delay                         | Orderable part number<br>TPS3435xD, TPS3435xJ                           | 0.9  | 1   | 1.1  |      |
|                   |  | Orderable part number<br>TPS3435xE, TPS3435xK                           | 4.5  | 5   | 5.5  | s    |
|                   |  | Orderable part number<br>TPS3435xF, TPS3435xL                           | 9    | 10  | 11   |      |
|                   |  | Orderable part number<br>TPS3435xxxxB                                   | 1.6  | 2   | 2.4  | ms   |
|                   |  | Orderable part number TPS3435xxxxC                                      | 9    | 10  | 11   | ms   |
|                   |  | Orderable part number<br>TPS3435xxxxD                                   | 22.5 | 25  | 27.5 | ms   |
|                   |  | Orderable part number TPS3435xxxxE                                      | 45   | 50  | 55   | ms   |
| t <sub>WDO</sub>  | Watchdog assert time delay                     | Orderable part number TPS3435xxxxF                                      | 90   | 100 | 110  | ms   |
|                   |  | Orderable part number<br>TPS3435xxxxG                                   | 180  | 200 | 220  | ms   |
|                   |  | Orderable part number<br>TPS3435xxxxH                                   | 0.9  | 1   | 1.1  | s    |
|                   |  | Orderable part number<br>TPS3435xxxxI                                   | 9    | 10  | 11   | s    |
| t MR_WDO          | Propagation delay from MR low to WDO assertion | V <sub>DD</sub> ≥ 1.25V,<br>MR = V <sub>MR_H</sub> to V <sub>MR_L</sub> |      | 100 |      | ns   |

<sup>(1)</sup> Specified by design parameter.



# **6.8 Timing Diagrams**

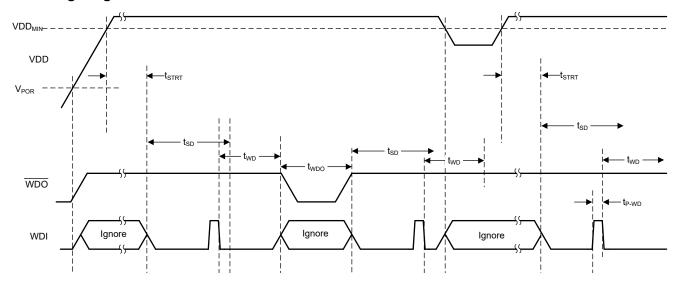
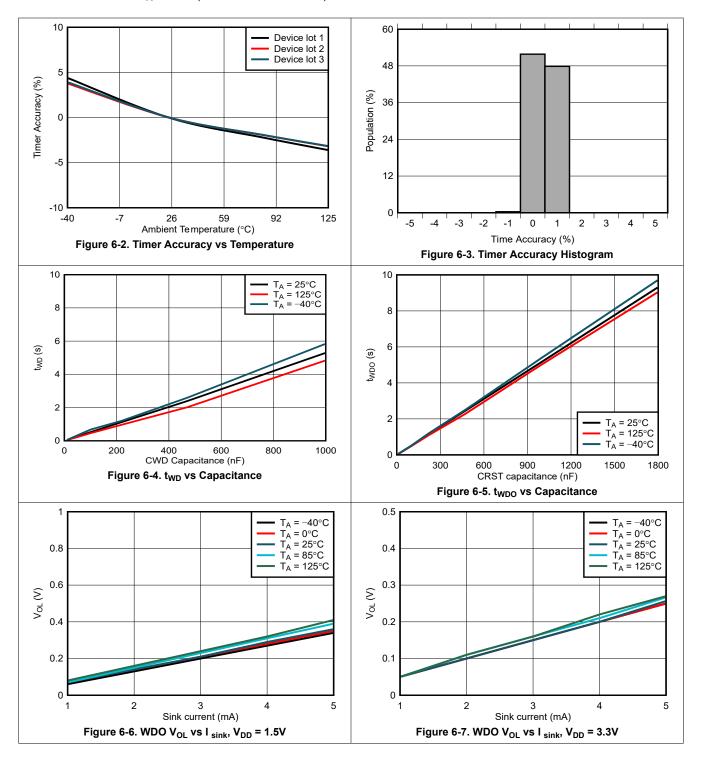


Figure 6-1. Functional Timing Diagram

## **6.9 Typical Characteristics**

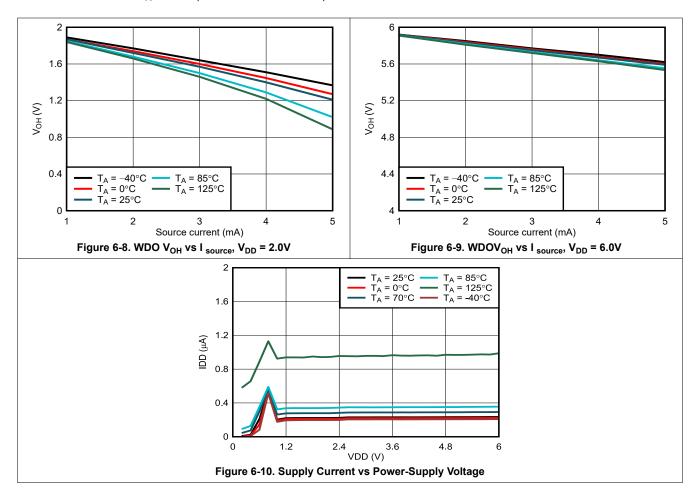
all curves are taken at T<sub>A</sub> = 25°C (unless otherwise noted)





### **6.9 Typical Characteristics (continued)**

all curves are taken at T<sub>A</sub> = 25°C (unless otherwise noted)



### 7 Detailed Description

### 7.1 Overview

The TPS3435-Q1 is a high-accuracy timeout watchdog timer device. The device family supports multiple features related to watchdog operation in a compact 8 pin SOT23 package. The devices are available in 3 different pinout configurations. Each pinout offers access to different features to meet the various application requirements. The device family is rated for AEC-Q100 applications.

## 7.2 Functional Block Diagrams

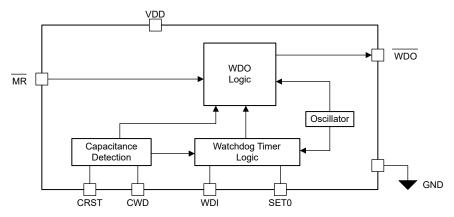


Figure 7-1. Pinout Option A

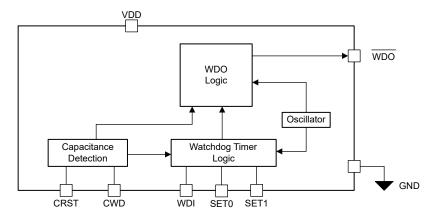


Figure 7-2. Pinout Option B

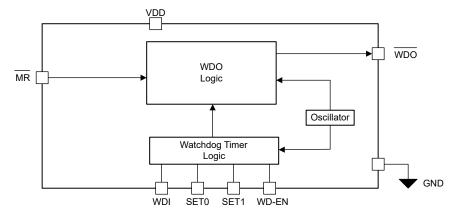


Figure 7-3. Pinout Option C

### 7.3 Feature Description

#### 7.3.1 Timeout Watchdog Timer

The TPS3435-Q1 offers high precision timeout watchdog timer monitoring. The device is available in multiple pinout options A to C which support multiple features to meet ever expanding needs of various applications. Make sure a correct pinout is selected to meet the application needs.

The timeout watchdog is active when the VDD voltage is higher than the VDD<sub>MIN</sub>, MR voltage is held higher than 0.7 x VDD and watchdog is enabled. TPS3435-Q1 family offers various startup time delay options to make sure enough time is available for the host to complete boot operation. Please refer Section 7.3.1.3 for additional details.

The timeout watchdog timer monitors the WDI pin for falling edge in the time frame defined by two time period. Refer Section 7.3.1.1 section to arrive at the relevant t<sub>WD</sub> value needed for application. The timer value is reset when a valid falling edge is detected on WDI pin in the two time duration. When a valid WDI transition is not detected in t<sub>WD</sub> time, the device asserts WDO output. The WDO is asserted for time t<sub>WDO</sub>. Refer Section 7.3.3 to arrive at the relevant t<sub>WDO</sub> value needed for application.

Figure 7-4 shows the basic operation for timeout watchdog timer operation. The TPS3435-Q1 watchdog functionality supports multiple features. Details are available in following sub sections.

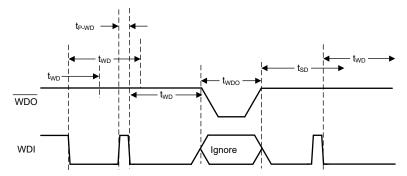


Figure 7-4. Timeout Watchdog Timer Operation

### 7.3.1.1 t<sub>WD</sub> Timer

The t<sub>WD</sub> timer for TPS3435-Q1 can be set using an external capacitor connected between CWD pin and GND pin. This feature is available with pinout options A or B. Applications which are space constrained or need timer values which meet offered timer options, can benefit when using pinout options C. The TPS3435-Q1 offers multiple fixed timer options ranging from 1ms up-to 100s.

The TPS3435-Q1, when using capacitance based timer, senses the capacitance value during the power up. The capacitor is charged and discharged with known internal current source for one cycle to sense the capacitance value. The sensed value is used to arrive at t<sub>WD</sub> timer for the watchdog operation. This unique implementation helps reduce the continuous charge and discharge current for the capacitor, thus reducing overall current consumption. Continuous charge and discharge of capacitance creates wider dead time (no watchdog monitor functionality) when capacitor is discharging. The dead time is higher for high value of capacitance. The unique implementation of TPS3435-Q1 helps avoid the dead time as the capacitance is not continuously charging or discharging under normal operation. Make sure  $C_{CWD}$  is < 200 x  $C_{CRST}$  for accurate calibration of capacitance. Equation 1 highlights the relationship between two in second and CWD capacitance in farad. The two timer is 20% accurate for the capacitor's typical value. Accuracy of the capacitance has additional impact on the two time. Make sure the capacitance meets the recommended operating range. Capacitance outside the recommended range can lead to incorrect operation of the device.

$$t_{WD}$$
 (sec) = 4.95 x 10<sup>6</sup> x  $C_{CWD}$  (F) (1)

The TPS3435-Q1 also offers wide selection of high accuracy fixed timer options starting from 1ms to 100sec including various industry standard values. The TPS3435-Q1 fixed time options are ±10% accurate for t<sub>WD</sub> ≥

Product Folder Links: TPS3435-Q1

10ms. For  $t_{WD}$  < 10ms, the accuracy is ±20%.  $t_{WD}$  value relevant to application can be identified from the orderable part number. Refer Section 4 section to identify mapping of orderable part number to  $t_{WD}$  value.

The TPS3435-Q1 offers flexibility to change the  $t_{WD}$  value on the fly by controlling the logic levels on the SETx pins. Section 7.3.1.4 section explains the advantages offered by this feature and the device behavior with various SETx pin combinations.

#### 7.3.1.2 Watchdog Enable Disable Operation

The TPS3435-Q1 supports watchdog enable or disable functionality. This functionality is critical for different use cases as listed below.

- · Disable watchdog during firmware update to avoid host RESET.
- Disable watchdog during software step-by-step debug operation.
- · Disable watchdog when performing critical task to avoid watchdog error interrupt.
- · Keep watchdog disabled until host boots up.

The TPS3435-Q1 supports watchdog enable or disable functionality through either WD-EN pin (pin configuration C) or SET[1:0] = 0b'01 (pin configuration B) logic combination. For a given pinout only one of these two methods is available for the user to disable watchdog operation.

For a pinout which offers a WD-EN pin, the watchdog enable disable functionality is controlled by the logic state of WD-EN pin. Drive WD-EN = 1 to enable the watchdog operation or drive WD-EN = 0 to disable the watchdog operation. The WD-EN pin can be toggled any time during the device operation. The Figure 7-5 diagram shows timing behavior with WD-EN pin control.

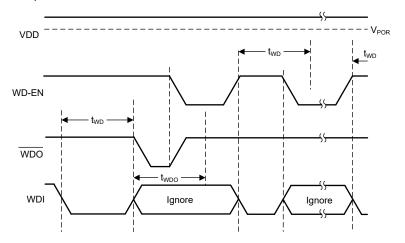


Figure 7-5. Watchdog Enable: WD-EN Pin Control

SET[1:0] = 0b'01 combination can be used to disable watchdog operation with a pinout which offers SET1 and SET0 pins, but does not include WD-EN pin. The SET pin logic states can be changed at any time during watchdog operation. Refer *Section 7.3.1.4* section for additional details regarding SET[1:0] pin behavior.

Pinout options A, B offer watchdog timer control using a capacitance connected between CWD and GND pin. A capacitance value higher than recommended or connect to GND leads to watchdog functionality getting disabled. Capacitance based disable operation overrides the other two options mentioned above. Changing capacitance on the fly does not enable or disable watchdog operation. A power supply recycle is needed to detect change in capacitance.

Ongoing watchdog frame is terminated when watchdog is disabled. WDO stays deasserted when watchdog operation is disabled. When enabled the device immediately enters  $t_{\text{WD}}$  frame and start watchdog monitoring operation.

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### 7.3.1.3 t<sub>SD</sub> Watchdog Start Up Delay

The TPS3435-Q1 supports watchdog startup delay feature. This feature is activated after power up or after WDO assert event. When  $t_{SD}$  frame is active, the device monitors the WDI pin but the WDO output is not asserted. This feature allows time for the host complete boot process before watchdog monitoring can take over. The start up delay helps avoid unexpected WDO assert events during boot. The  $t_{SD}$  time is predetermined based on the device part number selected. Refer *Section 4* section for details to map the part number to  $t_{SD}$  time. Pinout option A, B are available only in no delay or 10 sec start up delay options.

To exit t<sub>SD</sub> frame, one of the following event must occur:

- The host provides a valid pulse transition on the WDI pin.
- Change in logic state of SET[1:0].
- Toggling of the WD\_EN pin.

The device enters watchdog monitoring phase after the device exits the t<sub>SD</sub> frame.

Failure to provide one of the exit condition within  $t_{SD}$  triggers the watchdog error by asserting the WDO output pin for  $t_D$ , this is observed in Figure 7-6.

The  $t_{SD}$  frame is not initiated when the watchdog functionality is enabled using WD-EN pin or SET[1:0] pin combination as described in Section 7.3.1.2 section.

Figure 7-6 shows the operation for  $t_{SD}$  time frame.

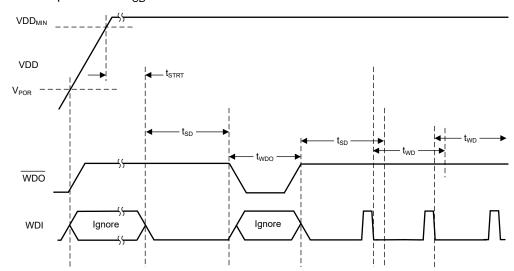


Figure 7-6. t<sub>SD</sub> Frame Behavior

#### 7.3.1.4 SET Pin Behavior

The TPS3435-Q1 offers one or two SET pins based on the pinout option selected. SET pins offer flexibility to the user to program the  $t_{WD}$  timer on the fly to meet various application requirements. Typical use cases where SET pin can be used are:

- Use wide timeout timer when host is in sleep mode, change to small timeout operation when host is
  operational. Watchdog can be used to wake up the host after long duration to perform the application related
  activities before going back to sleep.
- Change to wide timeout timer when performing system critical tasks to make sure the watchdog does not interrupt the critical task. Change timer to application specified interval after the critical task is complete.

The  $t_{WD}$  timer value for the device is combination of timer selection based on the CWD pin or fixed timer value along with SET pin logic level. The base  $t_{WD}$  timer value is decided based on the Watchdog Time selector in the Section 4 section. The SET pin logic level is decoded during the device power up. The SET pin value can be changed any time during the operation. SETx pin change which leads to change of watchdog timer value or enable disable state, terminates the ongoing watchdog frame immediately. SETx pins can be updated when

WDO output is asserted as well. The updated  $t_{WD}$  timer value is going be applied after output is deasserted and the  $t_{SD}$  timer is over or terminated.

For a pinout which offers only SET0 pin to the user, the  $t_{WD}$  multiplier value is decided based on the Watchdog Time Scaling selector in the Section 4 section. Table 7-1 showcases an example of the  $t_{WD}$  values for different SET0 logic levels when using Watchdog Time setting as option D = 10ms.

Table 7-1. two Scaling with SET0 Pin Only (Pin Configuration A)

|                                 | <u> </u>        | ,        |  |  |  |  |
|---------------------------------|-----------------|----------|--|--|--|--|
| WATCHDOG TIME SCALING SELECTION | t <sub>WD</sub> |          |  |  |  |  |
| WATCHDOG TIME SCALING SELECTION | SET0 = 0        | SET0 = 1 |  |  |  |  |
| A                               | 10ms            | 20ms     |  |  |  |  |
| В                               | 10ms            | 40ms     |  |  |  |  |
| С                               | 10ms            | 80ms     |  |  |  |  |
| D                               | 10ms            | 160ms    |  |  |  |  |
| E                               | 10ms            | 320ms    |  |  |  |  |
| F                               | 10ms            | 640ms    |  |  |  |  |
| G                               | 10ms            | 1280ms   |  |  |  |  |

For pinouts which offer both SET0 & SET1 pins to the user, the  $t_{WD}$  multiplier value is decided based on the Watchdog Time Scaling selector in the *Section 4* section. Two SETx pins offer 3 different time scaling options. The SET[1:0] = 0b'01 combination disables the watchdog operation. Table 7-2 showcases an example of the  $t_{WD}$  values for different SET[1:0] logic levels when using Watchdog Time setting as option G = 100ms. The package pin out selected does not offer WD-EN pin.

Table 7-2. t<sub>WD</sub> Scaling with SET0 & SET1 Pins, WD-EN Pin Not Available (Pin Configuration B)

|                   |                  | •                | •                |                  |  |  |  |  |  |
|-------------------|------------------|------------------|------------------|------------------|--|--|--|--|--|
| WATCHDOG TIME     | t <sub>WD</sub>  |                  |                  |                  |  |  |  |  |  |
| SCALING SELECTION | SET[1:0] = 0b'00 | SET[1:0] = 0b'01 | SET[1:0] = 0b'10 | SET[1:0] = 0b'11 |  |  |  |  |  |
| Α                 | 100ms            | Watchdog disable | 200ms            | 400ms            |  |  |  |  |  |
| В                 | 100ms            | Watchdog disable | 400ms            | 800ms            |  |  |  |  |  |
| С                 | 100ms            | Watchdog disable | 800ms            | 1600ms           |  |  |  |  |  |
| D                 | 100ms            | Watchdog disable | 1600ms           | 3200ms           |  |  |  |  |  |
| E                 | 100ms            | Watchdog disable | 3200ms           | 6400ms           |  |  |  |  |  |
| F                 | 100ms            | Watchdog disable | 6400ms           | 12800ms          |  |  |  |  |  |
| G                 | 100ms            | Watchdog disable | 12800ms          | 25600ms          |  |  |  |  |  |
|                   |                  |                  |                  |                  |  |  |  |  |  |

Selected pinout option can offer WD-EN pin along with SET[1:0] pins (Pin Configuration C). With this pinout, the WD-EN pin controls watchdog enable and disable operation. The SET[1:0] = 0b'01 combination operates as SET[1:0] = 0b'00.

Make sure the  $t_{WD}$  value with SETx multiplier does not exceed 640s. If a selection of timer and multiplier results in  $t_{WD}$  > 640s, the timer value is restricted to 640s.

Figure 7-7 to Figure 7-9 diagrams show the timing behavior with respect to SETx status changes.



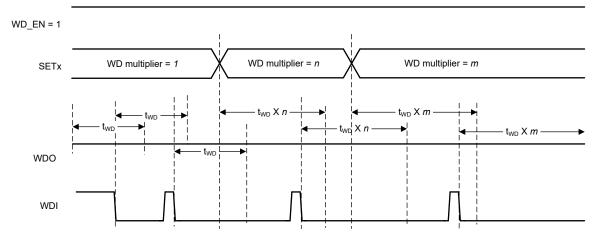
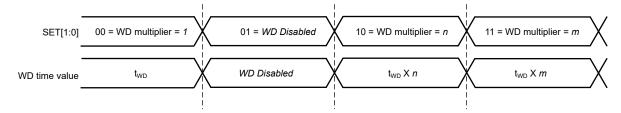
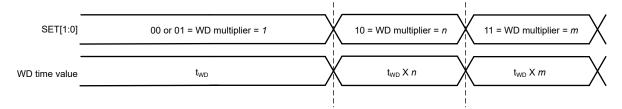


Figure 7-7. Watchdog Behavior with SETx Pin Status

## SET Pin (2 Pins) Operation; WD\_EN Pin Not Available

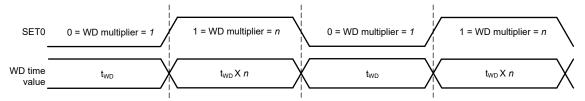


### SET Pin (2 Pins) Operation; WD\_EN Available = 1



 $\mathbf{t}_{\text{WD}}$  = Fixed based on OPN or programmable using capacitor n,m = Fixed based on timeset multiplier chosen

Figure 7-8. Watchdog Operation with 2 SET Pins



 $t_{\rm WD}$  = Fixed based on OPN or programmable using capacitor n = Fixed based on timeset multiplier chosen

Figure 7-9. Watchdog Operation with 1 SET Pin

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#### 7.3.2 Manual RESET

The TPS3435-Q1 supports manual reset functionality using  $\overline{MR}$  pin.  $\overline{MR}$  pin when driven with voltage lower than 0.3 x VDD, asserts the WDO output. The  $\overline{MR}$  pin has  $100k\Omega$  pull up to VDD. The  $\overline{MR}$  pin can be left floating. The internal pull up makes sure the output is not asserted due to  $\overline{MR}$  pin trigger.

The output is deasserted after MR pin voltage rises above 0.7 x VDD voltage. Refer Figure 7-10 for more details.

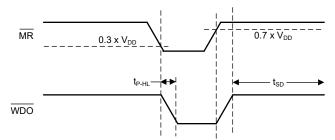


Figure 7-10. MR Pin Response

#### 7.3.3 WDO Output

The TPS3435-Q1 device offers WDO output pin. WDO output is asserted when  $\overline{MR}$  pin voltage is lower than 0.3 X VDD or watchdog timer error is detected.

The output is asserted for  $t_{WDO}$  time when any relevant events described above are detected, except for  $\overline{MR}$  event. The time  $t_{WDO}$  can be programmed by connecting a capacitor between CRST pin and GND or the device asserts  $t_{WDO}$  for fixed time duration as selected by orderable part number. Refer Section 4 section for all available options.

Equation 2 describes the relationship between capacitor value and the time  $t_{WDO}$ . Make sure the capacitance meets the recommended operating range. Capacitance outside the recommended range can lead to incorrect operation of the device.

$$t_{WDO} (sec) = 4.95 \times 10^6 \times C_{CRST} (F)$$
 (2)

TPS3435-Q1 also offers a unique option of latched output. An orderable with latched output holds the output in asserted state indefinitely until the device is power cycled or the error condition is addressed. If the output is latched due to  $\overline{\text{MR}}$  pin low voltage, the output latch is released when  $\overline{\text{MR}}$  pin voltage rises above 0.7 x V<sub>DD</sub> level. If the output is latched due to watchdog timer error, the output latch is be released when a WDI negative edge is detected or the device is shutdown and powered up again. Figure 7-11 shows timing behavior of the device with latched output configuration.

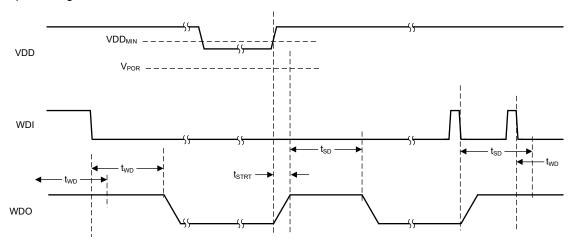


Figure 7-11. Output Latch Timing Behavior

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### 7.4 Device Functional Modes

Table 7-3 summarizes the functional modes of the TPS3435-Q1.

**Table 7-3. Device Functional Modes** 

| VDD                                | WATCHDOG STATUS | WDI  | WDO       |
|------------------------------------|-----------------|--|-----------|
| V <sub>DD</sub> < V <sub>POR</sub> | Not Applicable  | _  | Undefined |
| $V_{POR} \le V_{DD} < V_{DDmin}$   | Not Applicable  | Ignored  | High      |
|                                    | Disabled        | Ignored  | High      |
| $V_{DD} \ge V_{DDmin}$             | Enabled         | $t_{\text{pulse}}$ <sup>1</sup> < $t_{\text{WD(min)}}$ | High      |
|                                    | Enabled         | t <sub>pulse</sub> <sup>1</sup> > t <sub>WD(max)</sub> | Low       |

<sup>(1)</sup> Where  $t_{pulse}$  is the time between falling edges on WDI.

### 8 Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 8.1 Application Information

The following sections describe in detail proper device implementation, depending on the final application requirements.

#### 8.1.1 Output Assert Delay

The TPS3435-Q1 features two options for setting the output assert delay ( $t_{WDO}$ ): using a fixed timing and programming the timing through an external capacitor.

#### 8.1.1.1 Factory-Programmed Output Assert Delay Timing

Fixed output assert delay timings are available using pinout C . Using these timings enables a high-precision, 10% accurate output assert delay timing.

#### 8.1.1.2 Adjustable Capacitor Timing

The TPS3435-Q1 also utilizes a programmable output assert delay, using a precision current source to charge an external capacitor upon device startup. The typical delay time resulting from a given external capacitance on the CRST pin can be calculated by Equation 3, where  $t_{WDO}$  is the output assert delay time in seconds and  $C_{CRST}$  is the capacitance in microfarads.

$$t_{WDO} (sec) = 4.95 \times 10^6 \times C_{CRST} (F)$$
 (3)

Note that to minimize the difference between the calculated output assert delay time and the actual output assert delay time, use a high-quality ceramic dielectric COG, X5R, or X7R capacitor and minimize parasitic board capacitance around this pin. Table 8-1 lists the output assert delay time for typical capacitor values.

**OUTPUT ASSERT** C<sub>CRST</sub> DELAY TIME (t<sub>WDO</sub>) UNIT MIN<sup>(1)</sup> **TYP MAX**<sup>(1)</sup> 10nF 39.6 49.5 59.4 100nF 396 495 594 ms 1µF 3960 4950 5940 ms

Table 8-1. Output Assert Delay Time for Common Capacitor Values

## 8.1.2 Watchdog Timer Functionality

The TPS3435-Q1 features two options for setting the watchdog timer ( $t_{WD}$ ): using a fixed timing and programming the timing through an external capacitor.

#### 8.1.2.1 Factory-Programmed Timing Options

Fixed watchdog timeout options are available using pinout C. Using these timings enables a high-precision, 10% accurate watchdog timer  $t_{WD}$ .

### 8.1.2.2 Adjustable Capacitor Timing

Adjustable  $t_{WD}$  timing is achievable by connecting a capacitor to the CWD pin. If this method is used, please consult Equation 1 for calculating typical  $t_{WD}$  values using the nominal capacitor value. Capacitor tolerances

Product Folder Links: TPS3435-Q1

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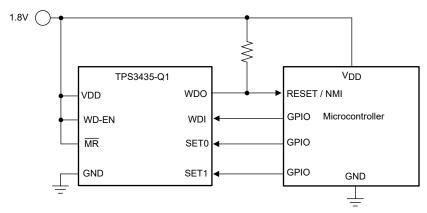
<sup>(1)</sup> Minimum and maximum values are calculated using capacitor's typical value.

cause the actual device timing to vary such that the minimum of  $t_{WD}$  can decrease and the maximum of  $t_{WD}$  can increase by the capacitor tolerance. For the most accurate timing, use ceramic capacitors with COG dielectric material.

### 8.2 Typical Applications

#### 8.2.1 Design 1: Monitoring a Standard Microcontroller for Timeouts

This example application uses the TPS3435CDDBBDDFRQ1 to monitor a microcontroller to make sure the device is not stalled during operation.



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Figure 8-1. Microcontroller Watchdog Monitoring Circuit

#### 8.2.1.1 Design Requirements

| PARAMETER                          | DESIGN REQUIREMENT             | DESIGN RESULT                               |
|------------------------------------|--------------------------------|---|
| Watchdog Timeout Period            | Typical timeout period of 40ms | Typical timeout period of 40ms              |
| Watchdog Output Assert Delay       | Typical output assert of 2ms   | Typical output assert of 2ms                |
| Startup Delay                      | Minimum startup delay of 700ms | Minimum startup delay of 900ms              |
| Output logic voltage               | Open-drain                     | Open-drain                                  |
| Maximum device current consumption | 20μΑ                           | 250nA typical, 3.0μA maximum <sup>(1)</sup> |

<sup>(1)</sup> Only includes the current consumption of the TPS3435-Q1.

#### 8.2.1.2 Detailed Design Procedure

#### 8.2.1.2.1 Setting the Watchdog Timeout Period

The watchdog timeout design requirement can be met either by using a fixed-timeout version of the TPS3435-Q1 or by connecting a capacitor between the CWD pin and GND. The typical values can be met with preprogrammed fixed time options, hence a pinout offering fixed time options is selected. Please see the Section 6.6 for a list of fixed timeouts. If using the CWD feature, please refer to Section 7.3.1.1 for instructions on how to program the timout period. In this application example, the 40ms timeout watchdog period is achieved by using watchdog time of 10ms (option D) and watchdog time scaling of 4 (option B). Connect SET[1:0] = 0b'10 to select watchdog time scaling of 4.

#### 8.2.1.2.2 Setting Output Assert Delay

Please see the Section 6.7 for a list of fixed timeouts. Timeout option B was chosen to meet the design requirement for a 2ms typical timeout.

#### 8.2.1.2.3 Setting the Startup Delay

Startup delay option D is chosen, which offers a startup delay of 1s. This accounts for the minimum specification of 700ms.

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#### 8.2.1.2.4 Calculating the WDO Pullup Resistor

The TPS3435-Q1 uses an open-drain configuration for the  $\overline{WDO}$  output, as shown in Figure 8-2. When the FET is off, the resistor pulls the drain of the transistor to VDD and when the FET is turned on, the FET pulls the output to ground, thus creating an effective resistor divider. The resistors in this divider must be chosen to make sure that  $V_{OL}$  is below the maximum value. To choose the proper pullup resistor, there are three key specifications to keep in mind: the pullup voltage ( $V_{PU}$ ), the recommended maximum  $\overline{WDO}$  pin current ( $I_{Sink}$ ), and  $V_{OL}$ . The maximum  $V_{OL}$  is 0.3V, meaning that the effective resistor divider created must be able to bring the voltage on the reset pin below 0.3V with  $I_{Sink}$  kept below 2mA for  $V_{DD} \ge 3V$  and 500μA for  $V_{DD} = 1.5V$ . For this example, with a  $V_{PU} = V_{DD} = 1.5V$ , a resistor must be chosen to keep  $I_{Sink}$  below 500μA because this value is the maximum consumption current allowed. To make sure this specification is met, a pullup resistor value of  $10k\Omega$  was selected, which sinks a maximum of  $150\mu$ A when  $\overline{WDO}$  is asserted.

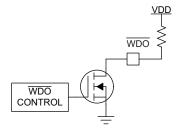


Figure 8-2. Open-Drain WDO Configuration

#### 8.3 Power Supply Recommendations

This device is designed to operate from an input supply with a voltage range between 1.04V and 6V. An input supply capacitor is not required for this device; however, if the input supply is noisy, then good analog practice is to place a 0.1µF capacitor between the VDD pin and the GND pin.

#### 8.4 Layout

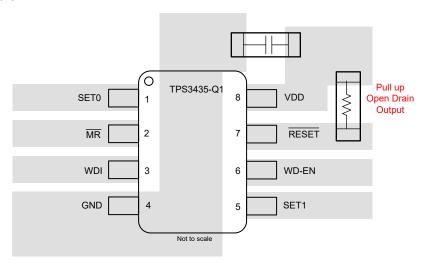
#### 8.4.1 Layout Guidelines

Make sure that the connection to the VDD pin is low impedance. Good analog design practice recommends placing a 0.1µF ceramic capacitor as near as possible to the VDD pin. If a capacitor is not connected to the CRST pin, then minimize parasitic capacitance on this pin so the WDO delay time is not adversely affected.

- Make sure that the connection to the VDD pin is low impedance. Good analog design practice is to place a 0.1μF ceramic capacitor as near as possible to the VDD pin.
- Place C<sub>CRST</sub> capacitor as close as possible to the CRST pin.
- Place C<sub>CWD</sub> capacitor as close as possible to the CWD pin.
- Place the pullup resistor on the WDO pin as close to the pin as possible.



## 8.4.2 Layout Example



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Figure 8-3. Typical Layout for the Pinout C of TPS3435-Q1



## 9 Device and Documentation Support

### 9.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 9.2 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

Product Folder Links: TPS3435-Q1

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### 9.3 Trademarks

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All trademarks are the property of their respective owners.

### 9.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 9.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

### 10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision A (June 2023) to Revision B (March 2025)   | Page |
|--|------|
| Added available device part table                                | 3    |
| Added t <sub>SD</sub> exit condition                             |      |
|  | _    |
| Changes from Revision * (October 2022) to Revision A (June 2023) | Page |
| Advance Information to Production Data release                   |      |
|  |      |

# 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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7-Nov-2025

#### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins        | Package qty   Carrier | RoHS | Lead finish/  | MSL rating/        | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|-----------------------|-----------------------|------|---------------|--------------------|--------------|--------------|
|                       | (1)    | (2)           |                       |                       | (3)  | Ball material | Peak reflow        |              | (6)          |
|                       |        |               |                       |                       |      | (4)           | (5)                |              |              |
| TPS3435AFACADDFRQ1    | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -45 to 125   | NLHOH        |
| TPS3435AFACADDFRQ1.A  | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -45 to 125   | NLHOH        |
| TPS3435BAACADDFRQ1    | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -45 to 125   | NLHOZ        |
| TPS3435BFADADDFRQ1    | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -45 to 125   | NLHOY        |
| TPS3435CAGBJDDFRQ1    | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 125   | NLHOM        |
| TPS3435CAGBJDDFRQ1.A  | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 125   | NLHOM        |
| TPS3435CAKAGDDFRQ1    | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -45 to 125   | NLHOJ        |
| TPS3435CAKAGDDFRQ1.A  | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -45 to 125   | NLHOJ        |
| TPS3435CCGAJDDFRQ1    | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -45 to 125   | NLHO5        |
| TPS3435CECAJDDFRQ1    | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 125   | NLHOP        |
| TPS3435CECAJDDFRQ1.A  | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 125   | NLHOP        |
| TPS3435CKHBDDDFRQ1    | Active | Production    | SOT-23-THIN (DDF)   8 | 3000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -45 to 125   | NLHO1        |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No. RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE OPTION ADDENDUM**

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#### OTHER QUALIFIED VERSIONS OF TPS3435-Q1:

Catalog: TPS3435

NOTE: Qualified Version Definitions:

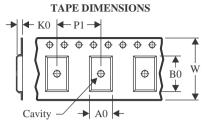
Catalog - TI's standard catalog product



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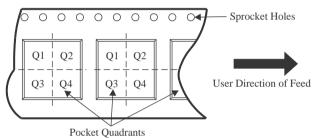
### TAPE AND REEL INFORMATION





| Γ | A0 | Dimension designed to accommodate the component width     |
|---|----|---|
|   | В0 | Dimension designed to accommodate the component length    |
|   | K0 | Dimension designed to accommodate the component thickness |
|   | W  | Overall width of the carrier tape                         |
|   | P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

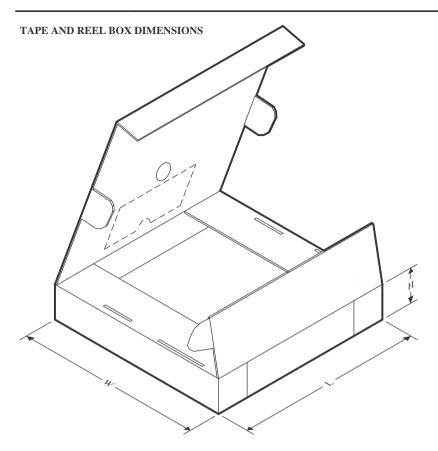


#### \*All dimensions are nominal

| Device             | Package<br>Type | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPS3435AFACADDFRQ1 | SOT-23-<br>THIN | DDF                | 8    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3435BAACADDFRQ1 | SOT-23-<br>THIN | DDF                | 8    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3435BFADADDFRQ1 | SOT-23-<br>THIN | DDF                | 8    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3435CAGBJDDFRQ1 | SOT-23-<br>THIN | DDF                | 8    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3435CAKAGDDFRQ1 | SOT-23-<br>THIN | DDF                | 8    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3435CCGAJDDFRQ1 | SOT-23-<br>THIN | DDF                | 8    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3435CECAJDDFRQ1 | SOT-23-<br>THIN | DDF                | 8    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3435CKHBDDDFRQ1 | SOT-23-<br>THIN | DDF                | 8    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |



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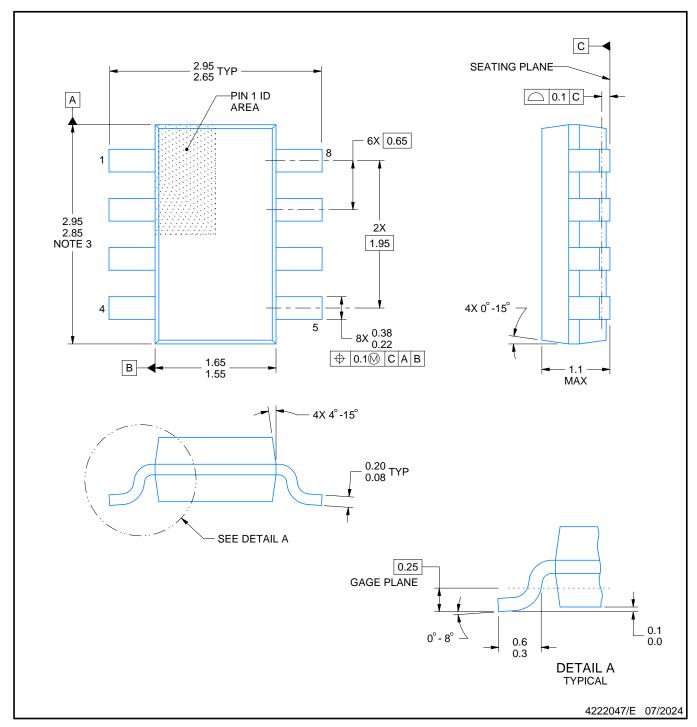


### \*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS3435AFACADDFRQ1 | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3435BAACADDFRQ1 | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3435BFADADDFRQ1 | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3435CAGBJDDFRQ1 | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3435CAKAGDDFRQ1 | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3435CCGAJDDFRQ1 | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3435CECAJDDFRQ1 | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3435CKHBDDDFRQ1 | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |



PLASTIC SMALL OUTLINE



### NOTES:

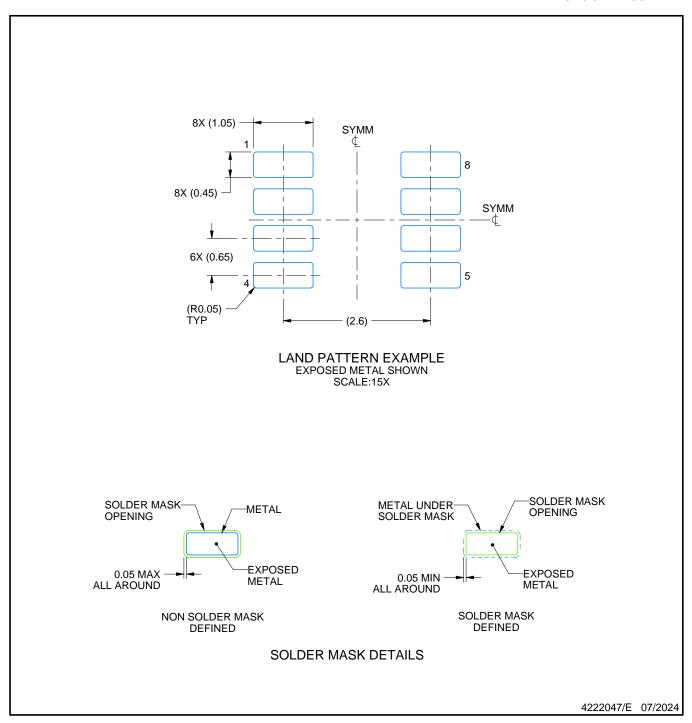
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.



PLASTIC SMALL OUTLINE

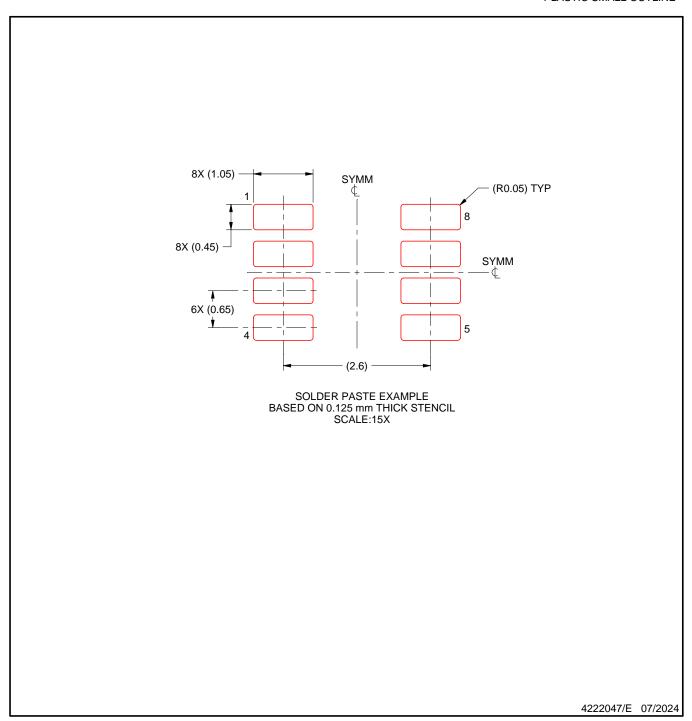


NOTES: (continued)

- 4. Publication IPC-7351 may have alternate designs.
- 5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



PLASTIC SMALL OUTLINE



NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 7. Board assembly site may have different recommendations for stencil design.



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